Inverters with open-drain outputs Rev. 6 — 4 July 2012

Product data sheet

1. **General description**

The 74LVC2G06 provides two inverting buffers.

The output of this device is an open drain and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions.

Input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

Schmitt trigger action at all inputs makes the circuit tolerant for slower input rise and fall time.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Features and benefits 2.

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- -24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Inverters with open-drain outputs

Ordering information 3.

Table 1. **Ordering information**

Type number	Package						
	Temperature range	Name	Description	Version			
74LVC2G06GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363			
74LVC2G06GV	–40 °C to +125 °C	TSOP6	plastic surface-mounted package (TSOP6); 6 leads	SOT457			
74LVC2G06GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1.45 \times 0.5$ mm	SOT886			
74LVC2G06GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1 \times 0.5$ mm	SOT891			
74LVC2G06GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 \times 1.0 \times 0.35 mm	SOT1115			
74LVC2G06GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202			

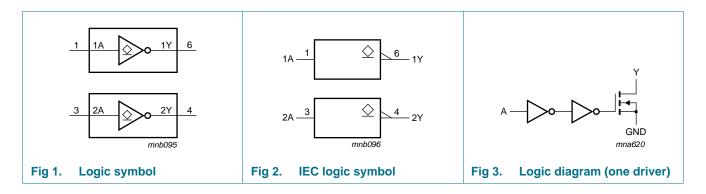
Marking 4.

Table 2. Marking

Type number	Marking code ^[1]
74LVC2G06GW	V6
74LVC2G06GV	V06
74LVC2G06GM	V6
74LVC2G06GF	V6
74LVC2G06GN	V6
74LVC2G06GS	V6

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

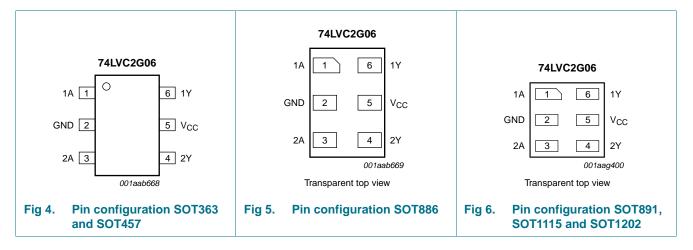
Functional diagram 5.



Inverters with open-drain outputs

Pinning information 6.

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
1A	1	data input
GND	2	ground (0 V)
2A	3	data input
2Y	4	data output
V _{CC}	5	supply voltage
1Y	6	data output

Functional description 7.

Function table^[1] Table 4.

Input nA	Output nY
L	Z
Н	L

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

Limiting values 8.

Table 5. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V

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In accordant	ce with the Absolute Maximum	Rating System (IEC 60134). Voltage	es are referenced to	GND (groun	d = 0 V).
Symbol	Parameter	Conditions	Min	Max	Unit
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1]</u> –0.5	+6.5	V
		Power-down mode	<u>[1][2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V \text{ to } 6.5 V$	-	50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u> _	250	mW

Table 5. Limiting values ... continued

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

When $V_{CC} = 0 V$ (Power-down mode), the output voltage can be 5.5 V in normal operation. [2]

For SC-88 and SC-74 packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K. [3] For XSON6 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

Recommended operating conditions 9.

Table 6. **Recommended operating conditions**

	1 0					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	5.5	V
		Power-down mode; $V_{CC} = 0 V$	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and	V_{CC} = 1.65 V to 2.7 V	-	-	20	ns/V
	fall rate	V_{CC} = 2.7 V to 5.5 V	-	-	10	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

	, ,			,			
Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -40) °C to +85 °C						
VIH	HIGH-level input	V _{CC} = 1.65 V to 1.95 V		$0.65 \times V_{CC}$	-	-	V
	voltage	V_{CC} = 2.3 V to 2.7 V		1.7	-	-	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$		2.0	-	-	V
		V_{CC} = 4.5 V to 5.5 V		$0.7\times V_{CC}$	-	-	V
V _{IL}	LOW-level input	V_{CC} = 1.65 V to 1.95 V		-	-	$0.35 \times V_{CC}$	V
	voltage	V_{CC} = 2.3 V to 2.7 V		-	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		-	-	0.8	V
		V_{CC} = 4.5 V to 5.5 V		-	-	$0.3 \times V_{CC}$	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$					
		I_{O} = 100 $\mu\text{A};$ V_{CC} = 1.65 V to 5.5 V		-	-	0.1	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$		-	-	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$		-	-	0.3	V
		I_{O} = 12 mA; V_{CC} = 2.7 V		-	-	0.4	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$		-	-	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$		-	-	0.55	V
I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	[2]	-	±0.1	±5	μA
I _{OZ}	OFF-state output current	$ V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = V_{CC} \text{ or } GND; $		-	±0.1	±10	μA
I _{OFF}	power-off leakage current	$V_{I} \text{ or } V_{O}$ = 5.5 V; V_{CC} = 0 V		-	±0.1	±10	μA
I _{CC}	supply current	$V_{I} = 5.5 V \text{ or GND}; I_{O} = 0 A;$ $V_{CC} = 1.65 V \text{ to } 5.5 V$		-	0.1	10	μA
ΔI_{CC}	additional supply current	per pin; V _I = V _{CC} – 0.6 V; I _O = 0 A; V _{CC} = 2.3 V to 5.5 V	<u>[2]</u>	-	5	500	μA
CI	input capacitance			-	2.5	-	pF

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Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -40	°C to +125 °C					
VIH	HIGH-level input	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
	voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	2.0	-	-	V
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	$0.7\times V_{CC}$	-	-	V
V _{IL}	LOW-level input	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35\times V_{CC}$	V
	voltage	V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	-	0.8	V
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	-	-	$0.3\times V_{CC}$	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 100 \ \mu\text{A}; \ V_{CC} = 1.65 \ \text{V} \text{ to } 5.5 \ \text{V}$	-	-	0.10	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.70	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.60	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.80	V
		$I_0 = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.80	V
I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	±20	μΑ
loz	OFF-state output current		-	-	±10	μΑ
OFF	power-off leakage current	$V_{\rm I}$ or $V_{\rm O}$ = 5.5 V; $V_{\rm CC}$ = 0 V	-	-	±20	μΑ
сс	supply current	$V_{I} = 5.5 V \text{ or GND}; I_{O} = 0 \text{ A};$ $V_{CC} = 1.65 V \text{ to } 5.5 V$	-	-	40	μA
∆l _{CC}	additional supply current	per pin; V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 2.3 V to 5.5 V	-	-	5000	μA

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at T_{amb} = 25 °C.

[2] These typical values are measured at V_{CC} = 3.3 V.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 8</u>.

Symbol	Parameter	Conditions	Conditions -40 °C to +85 °C -		–40 °C to +125 °C		Unit		
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nA to nY; see Figure 7	[2]						
		V_{CC} = 1.65 V to 1.95 V		1.0	3.2	6.5	1.0	8.2	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	2.0	3.9	0.5	4.9	ns
		$V_{CC} = 2.7 V$		1.0	2.6	4.2	1.0	5.3	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.5	2.3	3.4	0.5	4.3	ns
		$V_{CC} = 4.5 V$ to 5.5 V		0.5	1.6	2.9	0.5	3.7	ns
C _{PD}	power dissipation capacitance	V_{I} = GND to $V_{\text{CC}};V_{\text{CC}}$ = 3.3 V	<u>[3]</u>	-	5.9	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $\label{eq:tpd} [2] \quad t_{pd} \text{ is the same as } t_{PLZ} \text{ and } t_{PZL}.$

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = input frequency in MHz;$

 $f_o =$ output frequency in MHz;

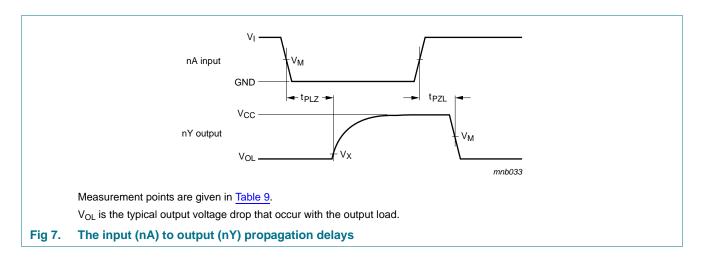
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

12. Waveforms



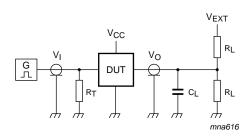
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NXP Semiconductors

74LVC2G06

Inverters with open-drain outputs

Table 9. Measurement points						
Supply voltage	Input	Output				
V _{CC}	V _M	V _M	V _X			
1.65 V to 1.95 V	$0.5\times V_{CC}$	$0.5 imes V_{CC}$	V _{OL} + 0.15 V			
2.3 V to 2.7 V	$0.5\times V_{CC}$	$0.5 imes V_{CC}$	V _{OL} + 0.15 V			
2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V			
3.0 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V			
4.5 V to 5.5 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	V _{OL} + 0.3 V			



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 8. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input		Load		V _{EXT}
V _{CC}	VI	t _r , t _f	CL	RL	t _{PZL} , t _{PLZ}
1.65 V to 1.95 V	V _{CC}	\leq 2.0 ns	30 pF	1 kΩ	$2 \times V_{CC}$
2.3 V to 2.7 V	V _{CC}	\leq 2.0 ns	30 pF	500 Ω	$2 \times V_{CC}$
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	6 V
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	6 V
4.5 V to 5.5 V	V _{CC}	\leq 2.5 ns	50 pF	500 Ω	$2 \times V_{CC}$

Inverters with open-drain outputs

13. Package outline

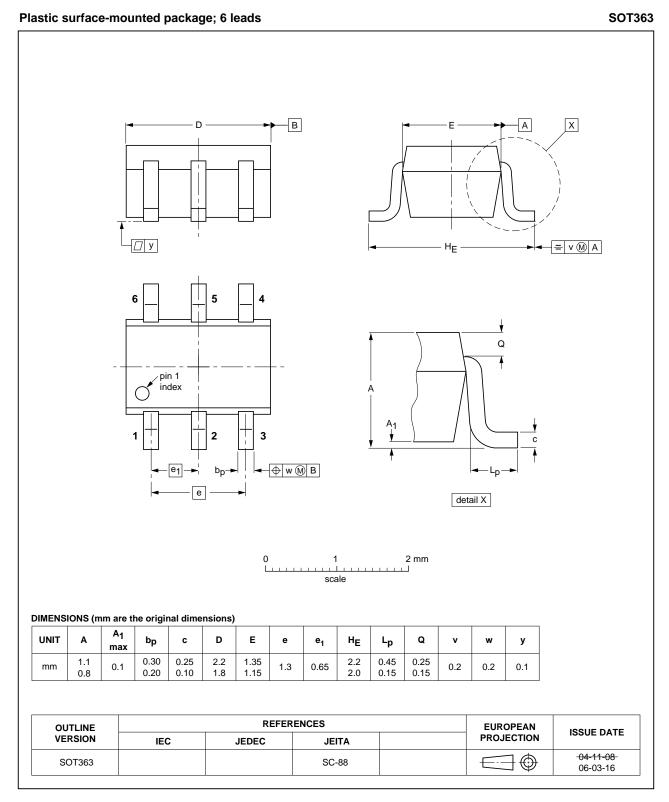


Fig 9. Package outline SOT363 (SC-88)

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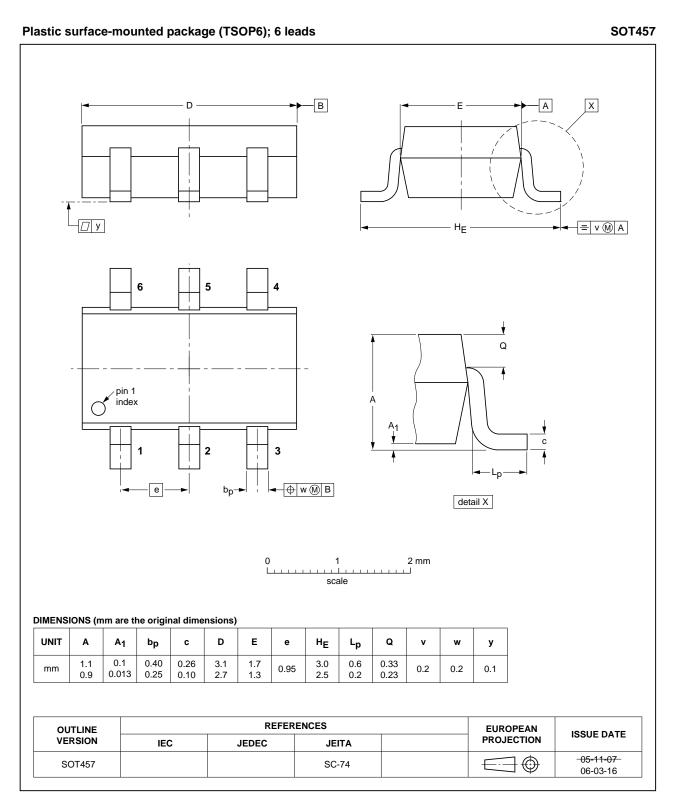


Fig 10. Package outline SOT457 (TSOP6)

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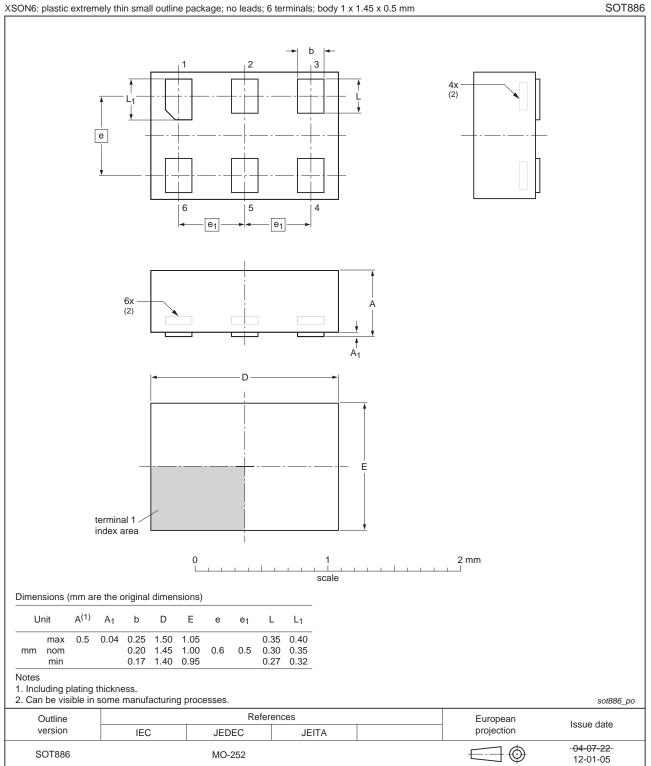


Fig 11. Package outline SOT886 (XSON6)

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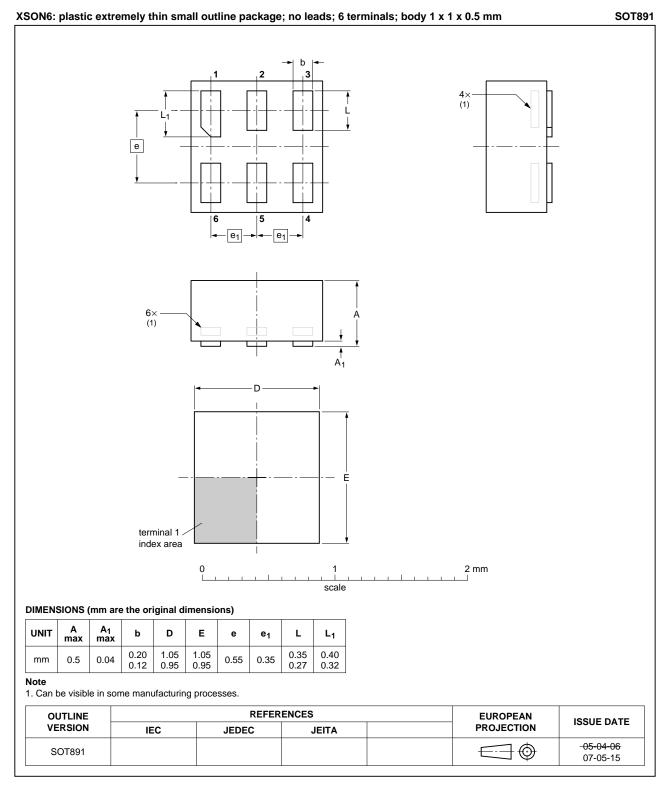
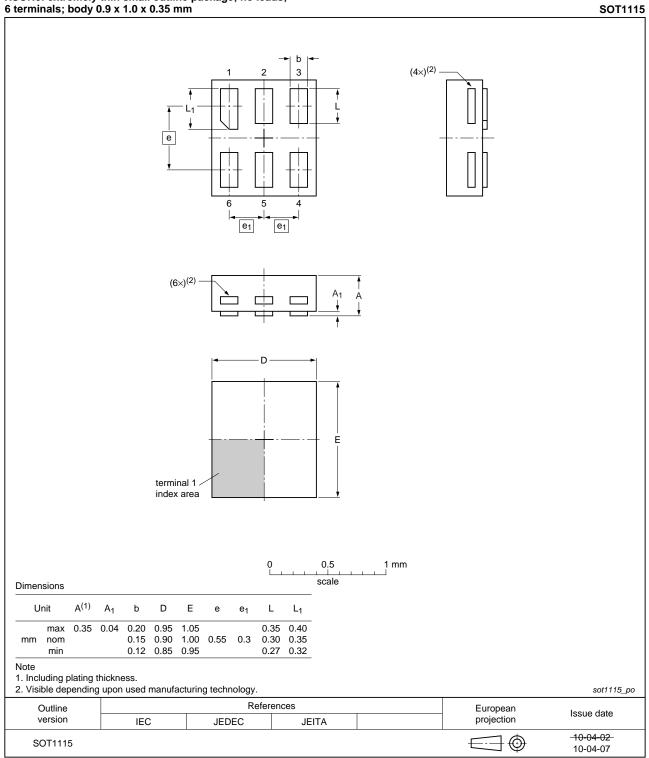


Fig 12. Package outline SOT891 (XSON6)

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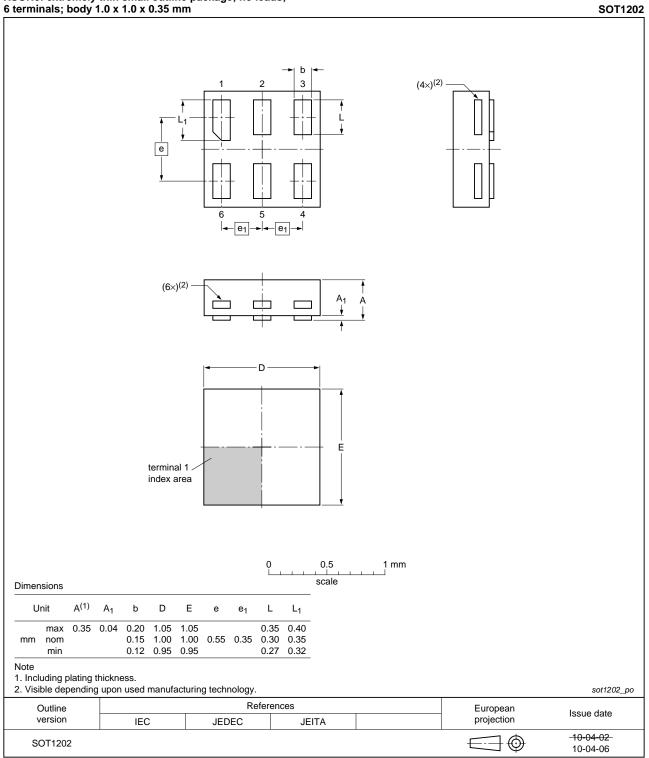
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XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 13. Package outline SOT1115 (XSON6)

Inverters with open-drain outputs



XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 14. Package outline SOT1202 (XSON6)

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14. Abbreviations

Table 11. Abbreviations				
Description				
Complementary Metal Oxide Semiconductor				
Device Under Test				
ElectroStatic Discharge				
Human Body Model				
Machine Model				
Transistor-Transistor Logic				

15. Revision history

Table 12. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC2G06 v.6	20120704	Product data sheet	-	74LVC2G06 v.5	
Modifications:	 Package ou 	tline drawing of SOT886 (F	igure 11) modified.		
74LVC2G06 v.5	20111130	Product data sheet	-	74LVC2G06 v.4	
Modifications:	 Legal pages 	s updated.			
74LVC2G06 v.4	20101028	Product data sheet	-	74LVC2G06 v.3	
74LVC2G06 v.3	20070521	Product data sheet	-	74LVC2G06 v.2	
74LVC2G06 v.2	20040910	Product specification	-	74LVC2G06 v.1	
74LVC2G06 v.1	20030825	Product specification	-	-	

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Inverters with open-drain outputs

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